# DATA SHEET

# LCD MODULE

# **GMD13002 SERIES**

Product specification

## GENERAL SPECIFICATION

# MODULE NO.:

# GMD13002 SERIES

#### **CUSTOMER P/N:**

VERSION NO.	CHANGE DESCRIPTION	DATE
0	ORIGINAL VERSION	2014/08/20

PREPARED BY: Xie Yaping DATE: 2014/08/20

APPROVED BY: Cheng Xiaojun DATE: 2014/08/20

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### **GMD13002 SERIES**

#### 1. FUNCTIONS & FEATURES

#### • LCD TYPE:

MODULE MODEL	LCD TYPE	REMARK
2864KLBLG03	1.30" OLED Passive Matrix White	

Driving Scheme : 1/64 Duty,
Viewing direction : 6 O'clock
Drive IC : SH1106
Power Supply Voltage : 3.0V
V<sub>CC</sub> : 12.0V
Interface : IIC

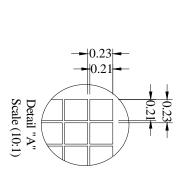
RoHS Compliant

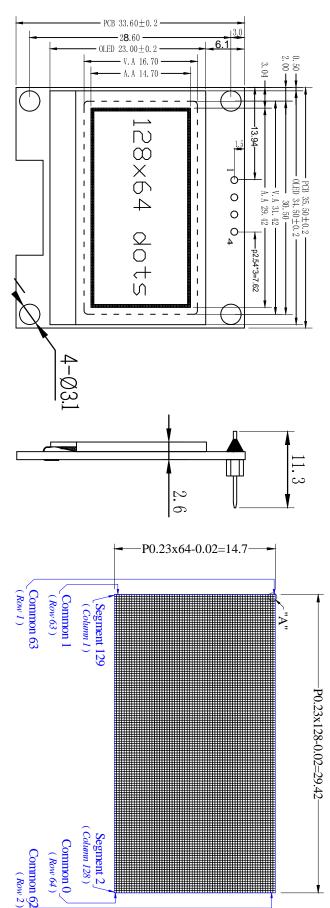
#### 2. MECHANICAL SPECIFICATIONS

Module Size : 35.50x33.70x2.60(max)mm
 Viewing Area : 31.42(L) x 16.70 (W) mm
 Active Area : 29.42 (L) x 14.70 (W) mm
 Dot Pitch : 0.23 (W) x 0.23 (H) mm
 Dot Size : 0.21(W) x 0.21(H) mm

### 3. EXTERNAL DIMENSIONS (♥☐ unit: mm)

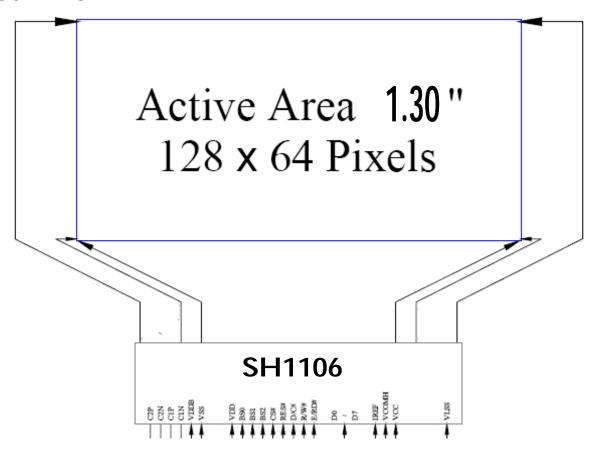
NOTES:
1.DISPLAY TYPE: 1.30" DLED BLUE/WHITE 2.LDGIC VOLTAGE: VDD=3.0V,
3.DRIVE METHOD: 1/64DUTY IC:SH1106
4.DPERATING TEMP: -40°C---+85°C
5.STORAGE TEMP: -45°C---+85°C
6.INTERFACE: I2C
7.UNNOTED TOLERANCE: ±0.2mm
8.ALL sub-parts and materials of the parts mustcomply with the RoHS instructions of EU.





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### 4. BLOCK DIAGRAM



### **5. PIN ASSIGNMENT**

PIN	SYMBOL	Descriptions					
1	VDD	Power Supply for Logic					
2	GND	Ground of Logic Circuit					
3	SCK	Serial clock input.					
4	SDA	Serial data input.					

#### 6. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	V <sub>DD</sub>	-0.3	4	V	1, 2
Supply Voltage for Display	V <sub>cc</sub>	0	16	V	1, 2
Supply Voltage for DC/DC	V <sub>BAT</sub>	-0.3	5	V	1, 2
Operating Temperature	T <sub>OP</sub>	-40	85	°C	
Storage Temperature	T <sub>STG</sub>	-40	85	°C	3
Life Time (120 cd/m²)		10,000	-	hour	4
Life Time (80 cd/m²)	***************************************	30,000	-	hour	4
Life Time (60 cd/m²)		50,000	-	hour	4

Note 1: All the above voltages are on the basis of " $V_{SS} = 0V$ ".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 3. "Optics & Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

Note 3: The defined temperature ranges do not include the polarizer. The maximum withstood temperature of the polarizer should be 80°C.

Note 4:  $V_{CC}$  = 12.0V,  $T_a$  = 25°C, 50% Checkerboard.

Software configuration follows Section 4.4 Initialization.

End of lifetime is specified as 50% of initial brightness reached. The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.

#### 7. ELECTRICAL CHARACTERISTICS

#### 7.1. Optics Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Мах	Unit
Brightness (V <sub>CC</sub> Supplied Externally)	$L_{br}$	Note 5	100	-	-	cd/m²
Brightness ( $V_{CC}$ Generated by Internal DC/DC)	$L_{br}$	Note 6	90	110	130	cd/m²
C.I.E. (Blue)	(x) (y)	C.I.E. 1931	0.12 0.22	0.16 0.26	0.20 0.30	
Dark Room Contrast	CR		-	2000:1	-	
Viewing Angle			-	Free	-	degree

<sup>\*</sup> Optical measurement taken at  $V_{DD}$  = 2.8V,  $V_{CC}$  = 12V & 8V. Software configuration follows Section 4.4 Initialization.

#### 7.2. DC CHARACTERISTICS

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage for Logic	V <sub>DD</sub>		1.65	2.8	3.3	٧
Supply Voltage for Display (Supplied Externally)	Vcc	Note 5 (Internal DC/DC Disable)	-	12	-	v
Supply Voltage for DC/DC	Vmr	Internal DC/DC Enable	3.5	-	4.2	V
Supply Voltage for Display (Generated by Internal DC/DC)	$v_{cc}$	Note 6 (Internal DC/DC Enable)	6.4	-	9	ν
High Level Input	$V_{\text{IH}}$	I <sub>OUT</sub> = 100μA, 3.3MHz	0.8×V <sub>DD</sub>	-	V <sub>DD</sub>	V
Low Level Input	V <sub>IL</sub>	I <sub>OUT</sub> = 100μA, 3.3MHz	0	-	0.2×V <sub>DD</sub>	٧
High Level Output	V <sub>OH</sub>	I <sub>OUT</sub> = 100μA, 3.3MHz	0.9×V <sub>DD</sub>	-	V <sub>DD</sub>	v
Low Level Output	V <sub>OL</sub>	I <sub>OUT</sub> = 100μA, 3.3MHz	0	-	0.1×V <sub>DD</sub>	٧
Operating Current for V <sub>DD</sub>	$\mathrm{I}_{DD}$		-	180	300	μΑ
Operating Current for V <sub>CC</sub> (V <sub>CC</sub> Supplied Externally)	Icc	Note 7	-	23	32	mA
Operating Current for V <sub>MT</sub> (V <sub>CC</sub> Generated by Internal DC/DC)	Ist7	Note 8	-	45	50	mA
Sleep Mode Current for V <sub>DD</sub>	I <sub>DD, SLEEP</sub>		-	1	5	μΑ
Sleep Mode Current for $V_{\text{CC}}$	I <sub>CC, SLEEP</sub>		-	2	10	μΑ

Note 5 & 6: Brightness (L<sub>br</sub>) and Supply Voltage for Display (V<sub>CC</sub>) are subject to the change of the panel characteristics and the customer's request.

Note 7:  $V_{DD} = 2.8V$ ,  $V_{CC} = 12V$ , IREF=910K 100% Display Area Turn on.

Note 8:  $V_{DD} = 2.8V$ ,  $V_{CC} = 8V$ , IREF=560K 100% Display Area Turn on.

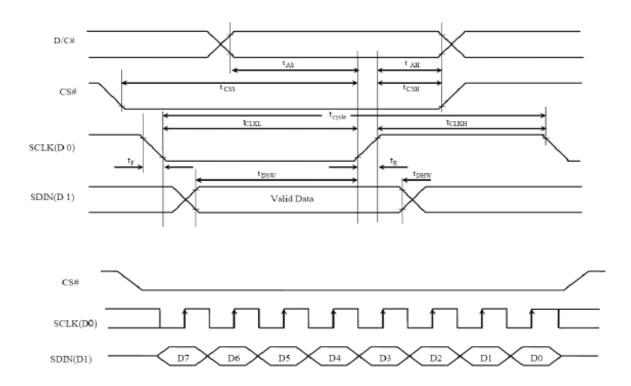
#### 7.3.AC CHARACTERISTICS

#### 3.3.3.1 Serial Interface Timing Characteristics: (4-wire SPI)

Symbol	Description	Min	Max	Unit
t <sub>cycle</sub>	Clock Cycle Time	100	-	ns
tas	Address Setup Time	15	-	ns
t <sub>AH</sub>	Address Hold Time	15	-	ns
t <sub>CSS</sub>	Chip Select Setup Time	20	-	ns
t <sub>CSH</sub>	Chip Select Hold Time	10	-	ns
t <sub>DSW</sub>	Write Data Setup Time	15	-	ns
t <sub>DHW</sub>	Write Data Hold Time	15	-	ns
t <sub>CLKL</sub>	Clock Low Time	20	-	ns
t <sub>CLKH</sub>	Clock High Time	20	-	ns
t <sub>R</sub>	Rise Time	-	40	ns
t <sub>F</sub>	Fall Time	-	40	ns

<sup>\* (</sup>V<sub>DD</sub> - V<sub>SS</sub> = 1.65V to 3.3V, T<sub>a</sub> = 25°C)

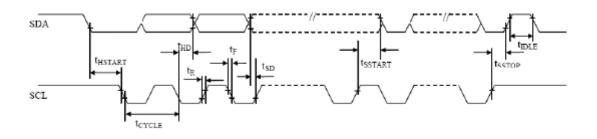
<sup>\*</sup> Software configuration follows Section 4.4 Initialization.



### 1 I<sup>2</sup>C Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t <sub>cycle</sub>	Clock Cycle Time	2.5	-	μs
t <sub>HSTART</sub>	Start Condition Hold Time	0.6	-	μs
	Data Hold Time (for "SDA <sub>OUT</sub> " Pin)	0		20
t <sub>HD</sub>	Data Hold Time (for "SDA <sub>IN</sub> " Pin)	300	_	ns
t <sub>SD</sub>	Data Setup Time	100	-	ns
t <sub>SSTART</sub>	Start Condition Setup Time (Only relevant for a repeated Start condition)	0.6	-	μs
t <sub>SSTOP</sub>	Stop Condition Setup Time	0.6	-	μs
t <sub>R</sub>	Rise Time for Data and Clock Pin		300	ns
t <sub>F</sub>	Fall Time for Data and Clock Pin		300	ns
t <sub>IDLE</sub>	Idle Time before a New Transmission can Start	1.3	-	μs

<sup>\* (</sup>V<sub>DD</sub> - V<sub>SS</sub> = 1.65V to 3.3V, T<sub>a</sub> = 25°C)



### 8. COMMANDS

Command		Code									Function	
Command	Α0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	runcuon
Set Column Address     4 lower bits	0	1	0	0	0	0	0	Lowe	er colu	mn ad	dress	Sets 4 lower bits of column address of display RAM in register. (POR = 00H)
Set Column     Address 4 higher     bits	0	1	0	0	0	0	1	High	er colu	mn ad	dress	Sets 4 higher bits of column address of display RAM in register. (POR = 10H)
Set Pump voltage value	0	1	0	0	0	1	1	0	0	volt	mp age lue	This command is to control the DC-DC voltage output value. (POR=32H)
Set Display Start     Line	0	1	0	0	1			Line a	ddress	,		Specifies RAM display line for COM0. (POR = 40H)
5. The Contrast Control Mode Set	0	1	0	1	0	0	0	0	0	0	1	This command is to set Contrast Setting of the display.
Contrast Data Register Set	0	1	0			(	Contra	st Data	3			The chip has 258 contrast steps from 00 to FF. (POR = 80H)
6. Set Segment Re-map (ADC)	0	1	0	1	0	1	0	0	0	0	ADC	The right (0) or left (1) rotation. (POR = A0H)
7. Set Entire Display OFF/ON	0	1	0	1	0	1	0	0	1	0	D	Selects normal display (0) or Entire Display ON (1). (POR = A4H)
8. Set Normal/ Reverse Display	0	1	0	1	0	1	0	0	1	1	D	Normal indication (0) when low, but reverse indication (1) when high. (POR = A6H)
9 Multiplex Ration Mode Set	0	1	0	1	0	1	0	1	0	0	0	This command switches default 63 multiplex mode to
Multiplex Ration Data Set	0	1	0	¥	x		ı	Multiplex Ratio				any multiplex ratio from 1 to 64. (POR = 3FH)
10. DC-DC Control Mode Set	0	1	0	1	0	1	0	1	1	0	1	This command is to control the DC-DC voltage DC-DC
DC-DC ON/OFF Mode Set	0	1	0	1	0	0	0	1	0	1	D	will be turned on when display on converter (1) or DC-DC OFF (0). (POR = 8BH)

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Command	Code								Function			
Command	Α0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	Function
11. Display OFF/ON	0	1	0	1	0	1	0	1	1	1	D	Turns on OLED panel (1) or turns off (0). (POR = AEH)
12. Set Page Address	0	1	0	1	0	1	1	F	Page A	\ddress	5	Specifies page address to load display RAM data to page address register. (POR = B0H)
13. Set Common Output Scan Direction	0	1	0	1	1	0	0	D	x	*	*	Scan from COMD to COM [N - 1] (0) or Scan from COM [N -1] to COMD (1). (POR = CDH)
14. Display Offset Mode Set	0	1	0	1	1	0	1	0	0	1	1	This is a double byte command which specifies
Display Offset Data Set	0	1	0	*	×			co	Mx			the mapping of display start line to one of COM0-63. (POR = 00H)
15. Set Display Divide Ratio/Oscillator Frequency Mode Set	0	1	0	1	1	0	1	0	1	0	1	This command is used to set the frequency of the internal display clocks. (POR = 50H)
Divide Ratio/Oscillator Frequency Data Set	0	1	0	Osc	illator l	Freque	ency		Divide	Ratio		
16. Dis-charge / Pre-charge Period Mode Set	0	1	0	1	1	0	1	1	0	0	1	This command is used to set the duration of the dis-charge and pre-charge
Dis-charge /Pre-charge Period Data Set	0	1	0	Dis	s-charg	ge Peri	iod	Pre	e-char	ge Peri	iod	period. (POR = 22H)
17. Common Pads Hardware Configuration Mode Set	0	1	0	1	1	0	1	1	0	1	0	This command is to set the common signals pad configuration. (POR = 12H)
Sequential/Alternat ive Mode Set	0	1	0	0	0	0	D	0	0	1	0	
18. VCOM Deselect Level Mode Set	0	1	0	1	1	0	1	1	0	1	1	This command is to set the common pad output voltage
VCOM Deselect Level Data Set	0	1	0			VC	OM (	3 X VREF)				level at deselect stage. (POR = 35H)
19. Read-Modify-Write	0	1	0	1	1	1	0	0	0	0	0	Read-Modify-Write start.
20. End	0	1	0	1	1	1	0	1	1	1	0	Read-Modify-Write end.
21. NOP	0	1	0	1	1	1	0	0	0	1	1	Non-Operation Command
22. Write Display Data	1	1	0		Write RAM data							
23. Read Status	0	0	1	BUSY	ON/ OFF	×	×	×	0	0	0	
24. Read Display Data	1	0	1			Read RAM data						

Note: Do not use any other command, or the system malfunction may result.

#### 9. FUNCTIONAL SPECIFICATION

#### 9.1 Commands

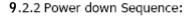
Refer to the Technical Manual for the SH1106

#### 9.2 Power down and Power up Sequence

To protect OEL panel and extend the panel life time, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the OEL panel enough time to complete the action of charge and discharge before/after the operation.

#### 9.2.1 Power up Sequence:

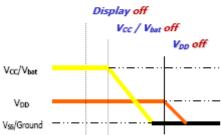
- Power up V<sub>DD</sub>
- 2. Send Display off command
- 3. Initialization
- 4. Clear Screen
- 5. Power up V<sub>CC</sub>/ V<sub>BAT</sub>
- Delay 100ms (When V<sub>CC</sub> is stable)
- 7. Send Display on command



- 1. Send Display off command
- Power down V<sub>CC</sub> / V<sub>BAT</sub>
- Delay 100ms (When V<sub>CC</sub> / V<sub>BAT</sub> is reach 0 and panel is completely discharges)
- 4. Power down VDD



VDD / VBAT OR



#### Note 13:

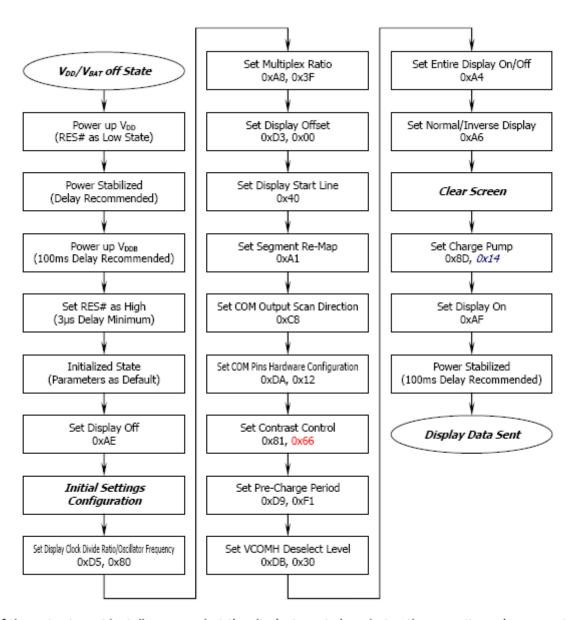
- Since an ESD protection circuit is connected between V<sub>DD</sub> and V<sub>CC</sub> inside the driver IC, V<sub>CC</sub> becomes lower than V<sub>DD</sub> whenever V<sub>DD</sub> is ON and V<sub>CC</sub> is OFF.
- V<sub>CC</sub> / V<sub>BAT</sub> should be kept float (disable) when it is OFF.
- Power Pins (VDD, VCC, VBAT) can never be pulled to ground under any circumstance.
- 4) VDD should not be power down before VCC / VBAT power down.

#### 9.3 Reset Circuit

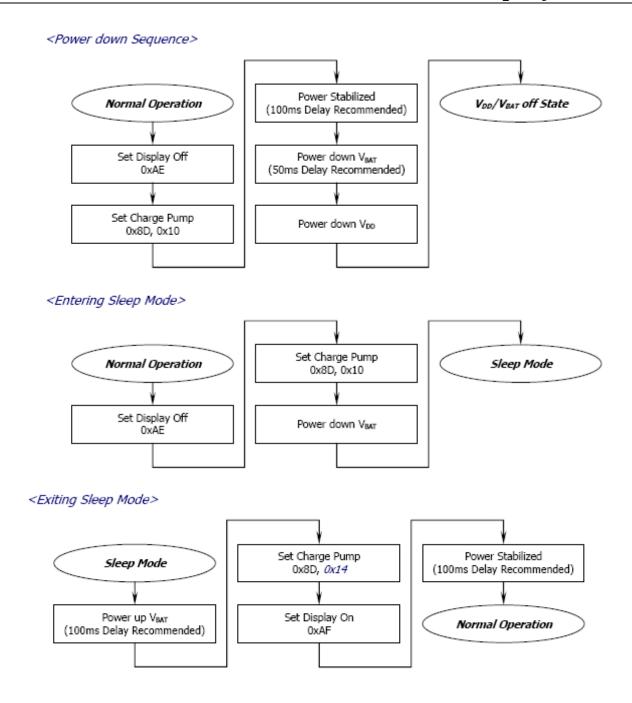
When RES# input is low, the chip is initialized with the following status:

- 1. Display is OFF
- 2. 128×64 Display Mode
- Normal segment and display data column and row address mapping (SEG0 mapped to column address 00h and COM0 mapped to row address 00h)
- 4. Shift register data clear in serial interface
- 5. Display start line is set at display RAM address 0
- 6. Column address counter is set at 0
- 7. Normal scan direction of the COM outputs
- 8. Contrast control register is set at 7Fh
- 9. Normal display mode (Equivalent to A4h command)

#### 9.4 Actual Application Example



If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.



### 10. MODULE ACCEPT QUALITY LEVEL (AQL)

10.1 AQL Standard Value: Critical Defect =0.1, Major Defect=0.65; Minor Defect =2.5.
10.2 Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II

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#### 11. RELIABILITY TEST.

#### 11.1 Contents of Reliability Tests

Item	Conditions	Criteria	
High Temperature Operation	70°C, 240 hrs		
Low Temperature Operation	-40°C, 240 hrs		
High Temperature Storage	85°C, 240 hrs	The operational	
Low Temperature Storage	-40°C, 240 hrs	functions work.	
High Temperature/Humidity Operation	60°C, 90% RH, 120 hrs		
Thermal Shock	-40°C ⇔ 85°C, 24 cycles 60 mins dwell		

<sup>\*</sup> The samples used for the above tests do not include polarizer.

#### 11.2 Failure Check Standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at  $23\pm5^{\circ}$ C;  $55\pm15^{\circ}$  RH.

#### 12. QUALITY DESCRIPTION & APPLICTION NOTE

Please refer to "General Inspection Criteria" document.

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<sup>\*</sup> No moisture condensation is observed during tests.